PCN Number:	20160711000			F	CN Da	te:	07/14/2016		
Title: Datasheet fo									
<b>Customer Contact:</b>	PCN Manager			De	Dept: Qua		lity Services		
Change Type:							-		
Assembly Site		Design			Wafer	Bum	p Site		
Assembly Process		Data Sheet			Wafer	- Bump Material			
Assembly Materials		Part number	Part number change 🛛 🗌 Wafer Bum		Bum	p Process			
Mechanical Specification		Test Site			Wafer	r Fab Site			
Packing/Shipping/Labeling		Test Process			Wafer	Fab Materials			
					Wafer	r Fab Process			
Notification Details									
Description of Change:									
Texas Instruments Incorporated is announcing an information only notification.									
The product datasheet(s) is updated as seen in the change revision history below:									
TLV320AIC3106-Q1									
SLAS663C - AUGUST 2009-REVISED	D JUNE 2016						www.ti.com		
Changes from Revision B (O	Changes from Revision B (October 2012) to Revision C Page								
<ul> <li>Added Applications section, Device Information table, Device Comparison Table, Table of Contents, Pin Configuration and Functions section, Specifications section, ESD Ratings table, Timing Requirements table,</li> </ul>									
Switching Characteristics to	able, <i>Timing and</i>	Switching Diagrams, De	ailed Description s	sectio	n, Applica	ation an	d		
Implementation section, Power Supply Recommendations section, Layout section, Device and Documentation									
Support section, and Mechanical, Packaging, and Orderable Information section									
Deleted Ordering Information Table; see POA at the end of the datasheet									
Changed R to R/W for Bit D0 for Page 0, Registers 79, 86, and 93									
Device Family	vice Esmily			Change From:			Change To:		
TLV320AIC3106-Q1			SLAS663B			SLAS663C			
These changes may be reviewed at the datasheet links provided.									
http://www.ti.com/lit/ds/symlink/tlv320aic3106-q1.pdf									
Reason for Change:									
To more accurately reflect device characteristics.									
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative): No anticipated impact. This is a specification change announcement only. There are no changes									
to the actual device.									
Changes to product identification resulting from this PCN:									
None.									
Product Affected:									
6PAIC3106IRGZRQ1									
For questions regarding		., .							

Location	E-Mail
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Japan	PCNJapanContact@list.ti.com